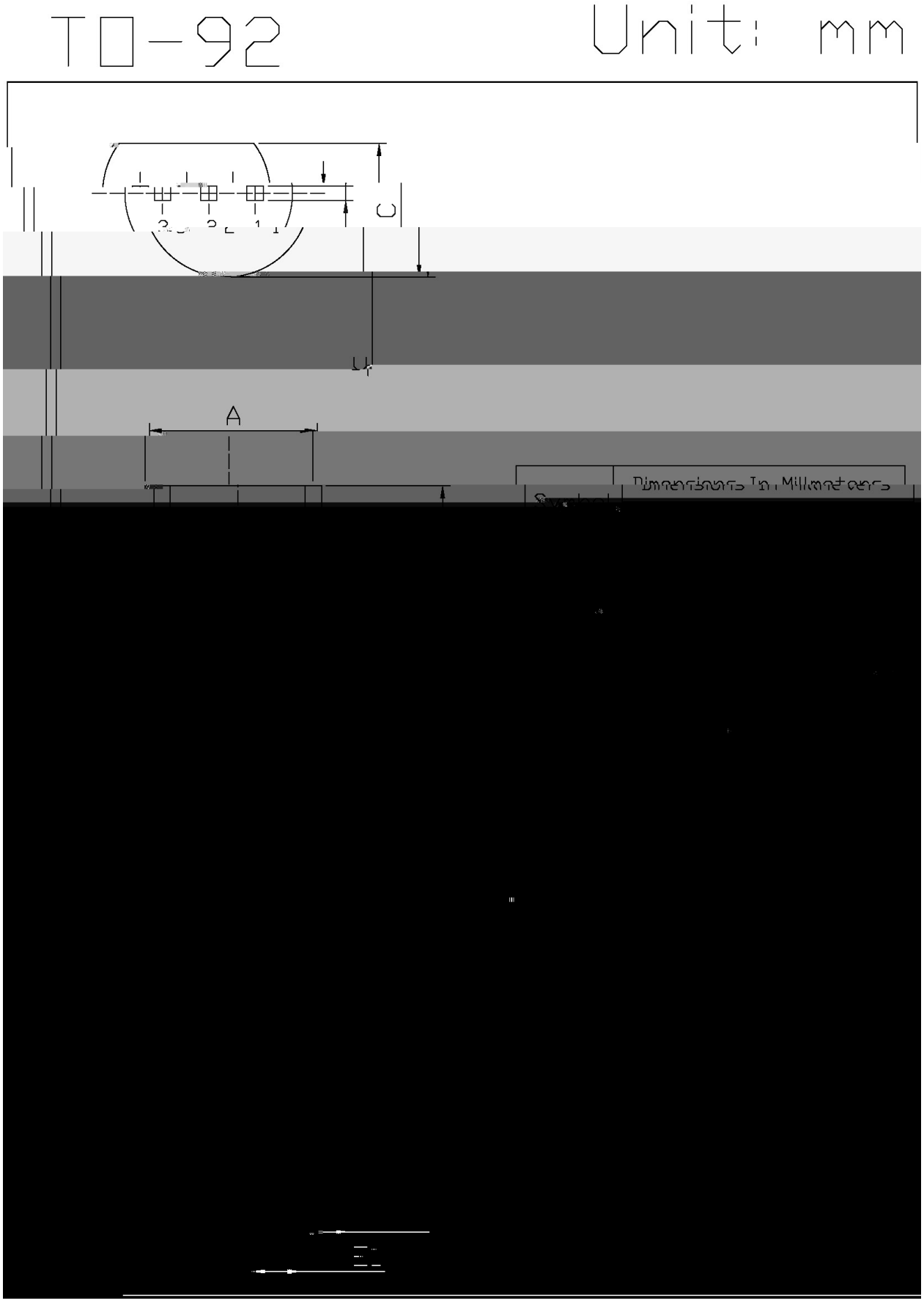
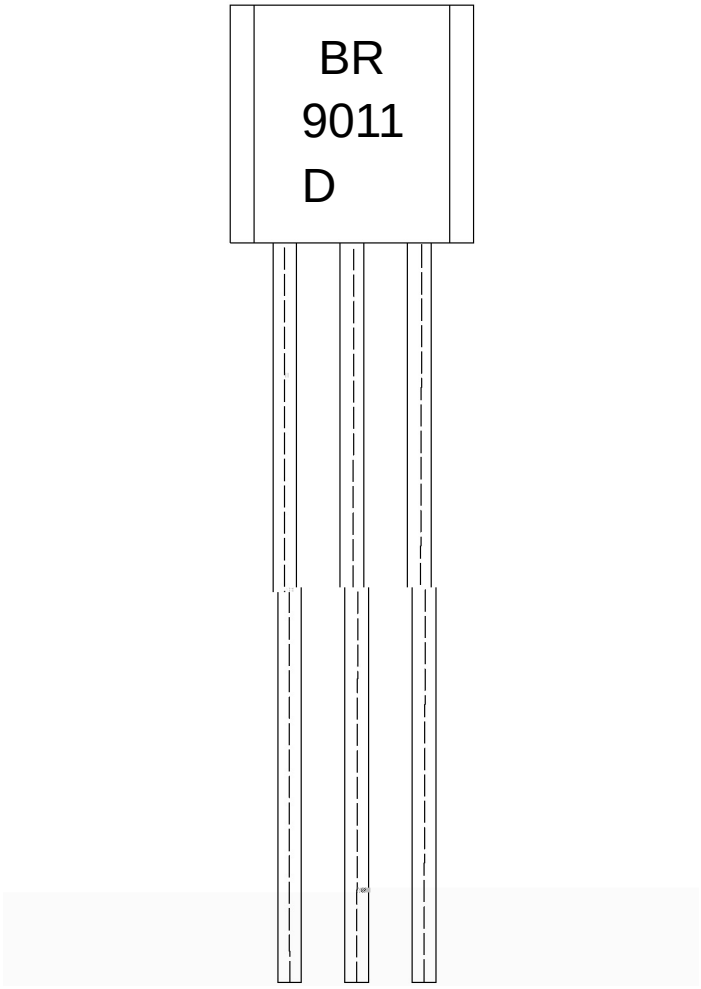
v ‴Ω Parameter	ϒ N Symbol	‴Ω Ö Rating	D Ч Unit
Collector to Base Voltage	V_{CBO}	50	V
Collector to Emitter Voltage	V_{CEO}	30	V
Emitter to Base Voltage	V_{EBO}	5.0	V
Collector Current - Continuous	I_C	30	mA
Base Current - Continuous	I_B	10	mA

/ Package Dimensions



/ Marking Instructions



ب ˝ χ	
EU χ	ѭ ҳ и Ґђ
<344 χ	ѭ ҙ N Ґђ
G=	ѭ k IH ‘ 6 Ґђ
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Note:

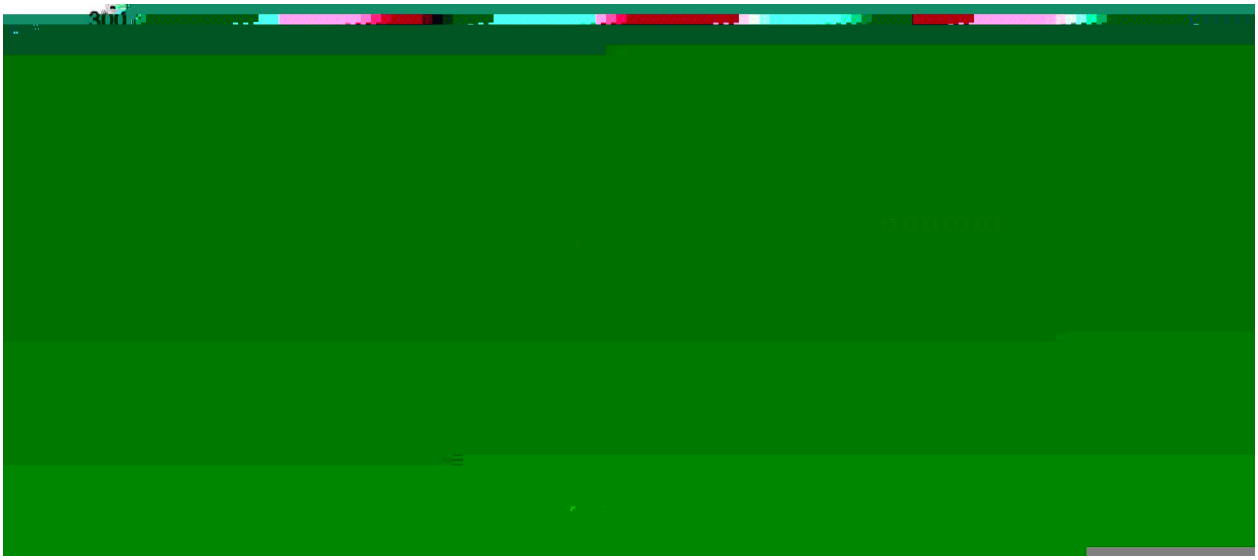
BR: Company Code.

9011: Product Type.

D: h_{FE} Classifications Symbol.

****: Lot No. Code, code change with Lot No.

( ) / Temperature Profile for Dip Soldering(Pb-Free)



ب ˝ χ

1 Ĺ ♬ □ ỷ 25 Ḱ 150 ɬ ı ˋH ڑ 60 Ḱ 90sec;

2 Š Ө □ ỷ 255 ° 5 ɬ ı ˋH ڑ ˋY ﾉ ㎞ 5 ° 0.5sec;

3 ì ˙ ϒ ˛ ɔ ෯ ỷ ㎞ 2 Ḱ 10 ɬ /sec.

Note:

1.Preheating:25~150 ɬ , Time:60~90sec.

2.Peak Temp.:255 ° 5 ɬ , Duration:5 ° 0.5sec.

3. Cooling Speed: 2~10 ɬ /sec.

/ Resistance to Soldering Heat Test Conditions

□ ỷ χ 270 ° 5 ɬ ˋH ڑ χ 10 ° 1 sec. Temp.:270±5 Time:10±1 sec

/ Packaging SPEC.

ˈQ ţ ϒ Ь / BULK

Package Type	Units					Dimension		(unit mm3)

ﾉ V ϒ Ь / AMMO

Package Type	Units					Dimension	(unit mm3)

/ Notices